

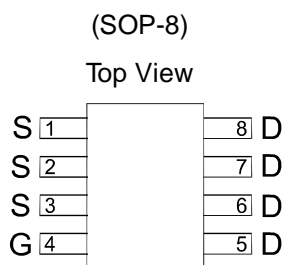
ME4435/ME4435-G

P-Channel 30V (D-S) MOSFET

GENERAL DESCRIPTION

The ME4435 is the P-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits where high-side switching and low in-line power loss are needed in a very small outline surface mount package.

PIN CONFIGURATION

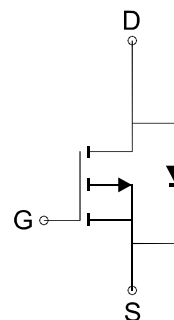


FEATURES

- $R_{DS(ON)} \leq 20m\Omega @ V_{GS} = -10V$
- $R_{DS(ON)} \leq 35m\Omega @ V_{GS} = -4.5V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability

APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter



P-Channel MOSFET

Ordering Information: ME4435 (Pb-free)

ME4435-G (Green product-Halogen free)

Absolute Maximum Ratings (TA=25°C Unless Otherwise Noted)

| Parameter | Symbol | Maximum Ratings | Unit |
|---|-----------------|--------------------|--------------|
| Drain-Source Voltage | V_{DS} | -30 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | V |
| Continuous Drain Current | I_D | $T_A = 25^\circ C$ | -8.8 |
| | | $T_A = 70^\circ C$ | -7.1 |
| Pulsed Drain Current | I_{DM} | -35 | A |
| Maximum Power Dissipation | P_D | $T_A = 25^\circ C$ | 2.5 |
| | | $T_A = 70^\circ C$ | 1.6 |
| Operating Junction Temperature | T_J | -55 to 150 | $^\circ C$ |
| Thermal Resistance-Junction to Ambient* | $R_{\theta JA}$ | 50 | $^\circ C/W$ |

*The device mounted on 1in² FR4 board with 2 oz copper

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P-Channel 30V (D-S) MOSFET
Electrical Characteristics ($T_A=25^\circ\text{C}$ Unless Otherwise Specified)

| Symbol | Parameter | Limit | Min | Typ | Max | Unit |
|----------------|---|--|-----|------|-----------|---------------|
| STATIC | | | | | | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS}=V_{GS}, I_D=-250\ \mu\text{A}$ | -1 | -1.4 | -3 | V |
| I_{GSS} | Gate Leakage Current | $V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$ | | | ± 100 | nA |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS}=-30\text{V}, V_{GS}=0\text{V}$ | | | -1 | μA |
| $I_{D(ON)}$ | On-State Drain Current ^a | $V_{DS}=-5\text{V}, V_{GS}=-10\text{V}$ | -30 | | | A |
| $R_{DS(ON)}$ | Drain-Source On-State Resistance ^a | $V_{GS}=-10\text{V}, I_D=-9.1\text{A}$ | | 15 | 20 | m Ω |
| | | $V_{GS}=-4.5\text{V}, I_D=-6.9\text{A}$ | | 25 | 35 | |
| V_{SD} | Diode Forward Voltage | $I_S=-2.1\text{A}, V_{GS}=0\text{V}$ | | -0.8 | -1.2 | V |
| DYNAMIC | | | | | | |
| Q_g | Total Gate Charge | $V_{DS}=-15\text{V}, V_{GS}=-10\text{V}, I_D=-9.1\text{A}$ | | 38 | | nC |
| Q_{gs} | Gate-Source Charge | | | 7.7 | | |
| Q_{gd} | Gate-Drain Charge | | | 9 | | |
| R_g | Gate Resistance | $V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$ | | 6.9 | | Ω |
| C_{iss} | Input capacitance | $V_{DS}=-15\text{V}, V_{GS}=0\text{V}, f=1\text{MHz}$ | | 1490 | | pF |
| C_{oss} | Output Capacitance | | | 209 | | |
| C_{rss} | Reverse Transfer Capacitance | | | 148 | | |
| $t_{d(on)}$ | Turn-On Delay Time | $V_{DD}=-15\text{V}, R_L=15\ \Omega$ $I_D=-1\text{A}, V_{GEN}=-10\text{V}$ $R_G=6\ \Omega$ | | 38.2 | | ns |
| t_r | Turn-On Rise Time | | | 16.7 | | |
| $t_{d(off)}$ | Turn-Off Delay Time | | | 106 | | |
| t_f | Turn-Off Fall Time | | | 24.1 | | |

 Notes: a. Pulse test: pulse width $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$, Guaranteed by design, not subject to production testing.

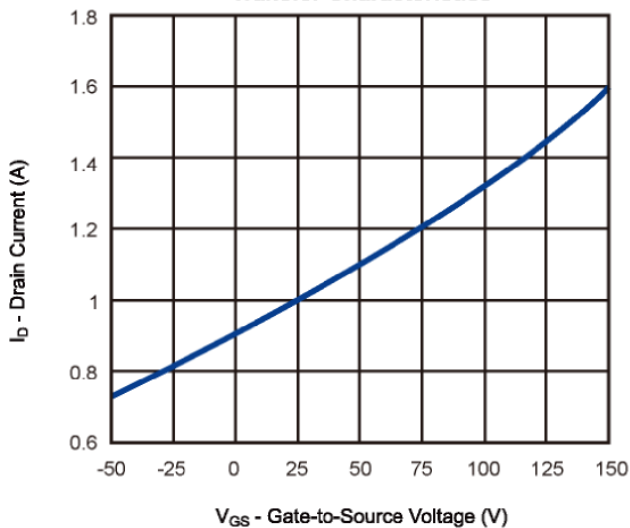
b. Matsuki Electric/ Force mos reserves the right to improve product design, functions and reliability without notice.

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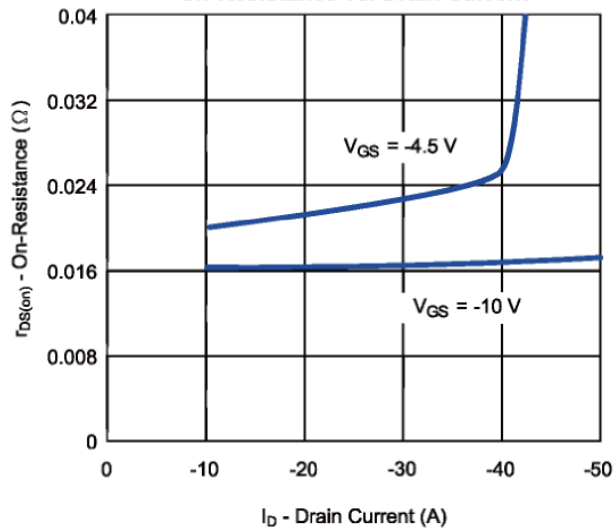
P-Channel 30V (D-S) MOSFET

Typical Characteristics (T_J = 25°C Noted)

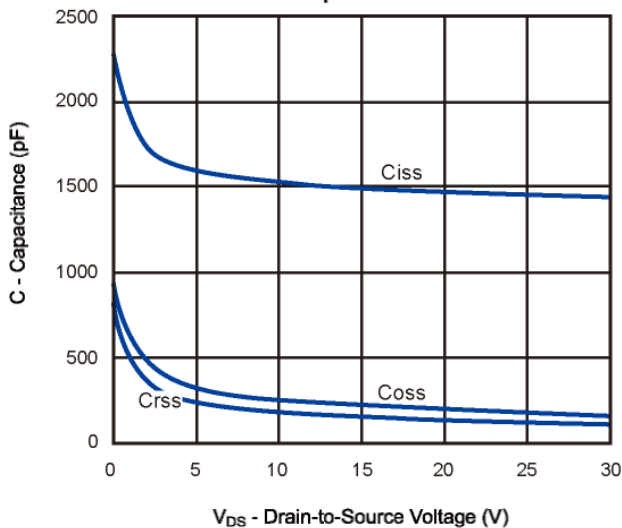
Transfer Characteristics



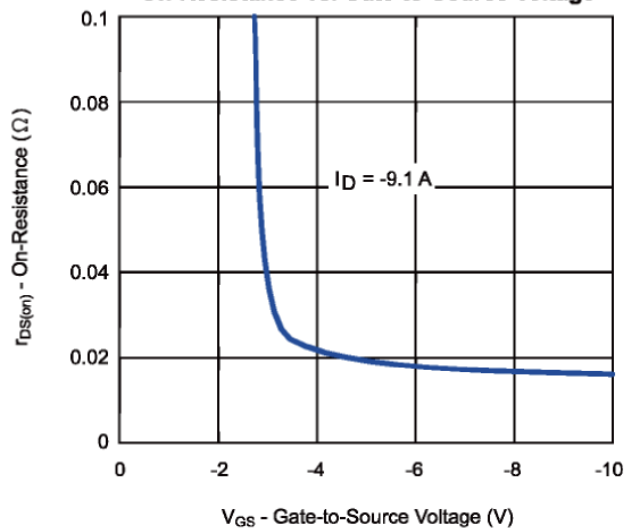
On-Resistance vs. Drain Current



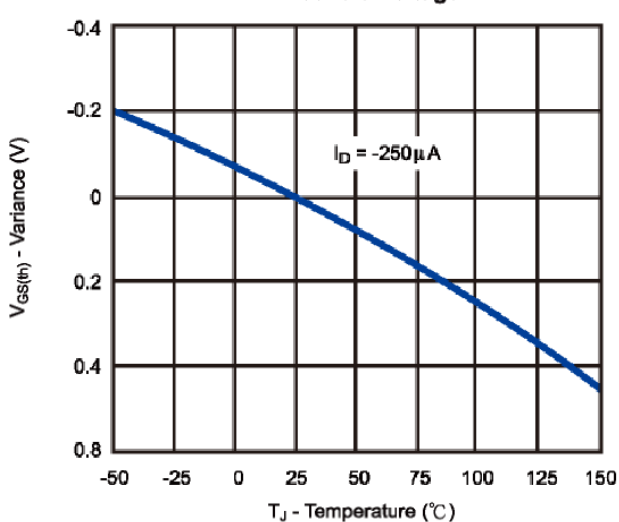
Capacitance



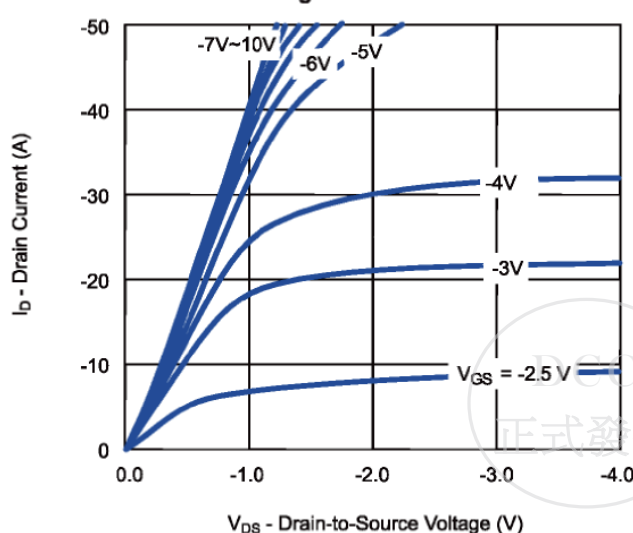
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage

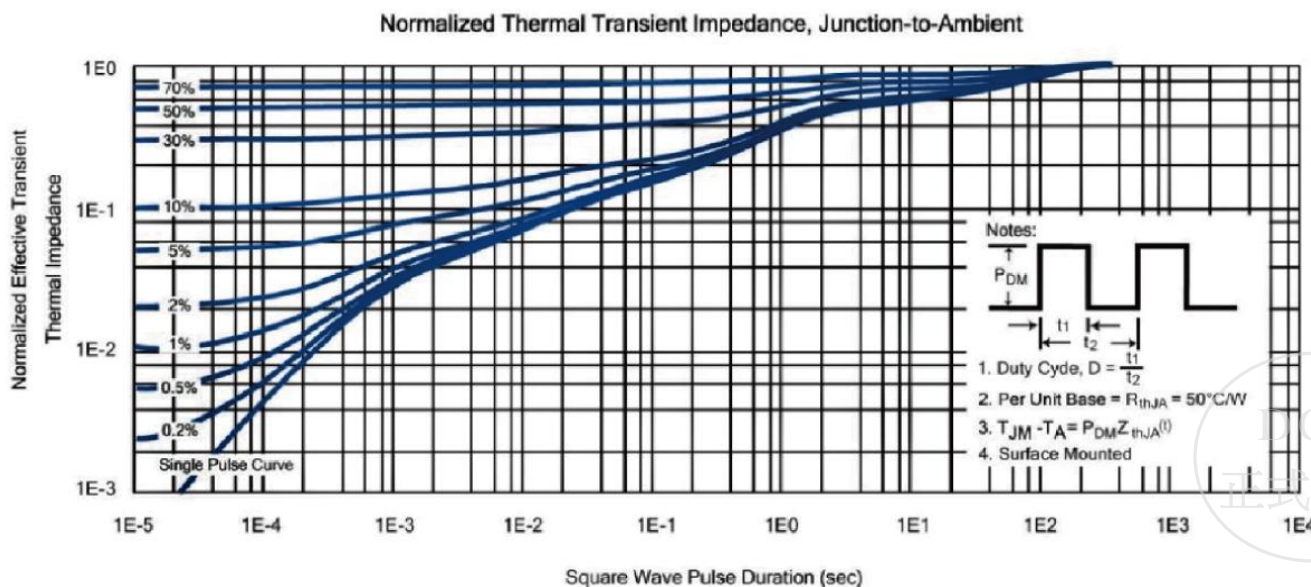
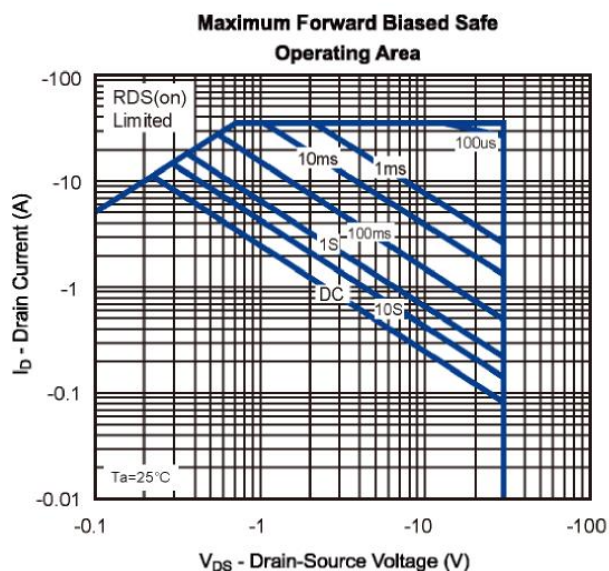
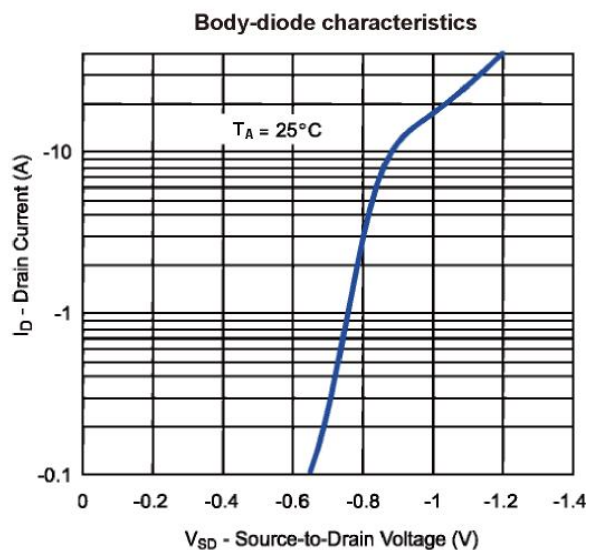
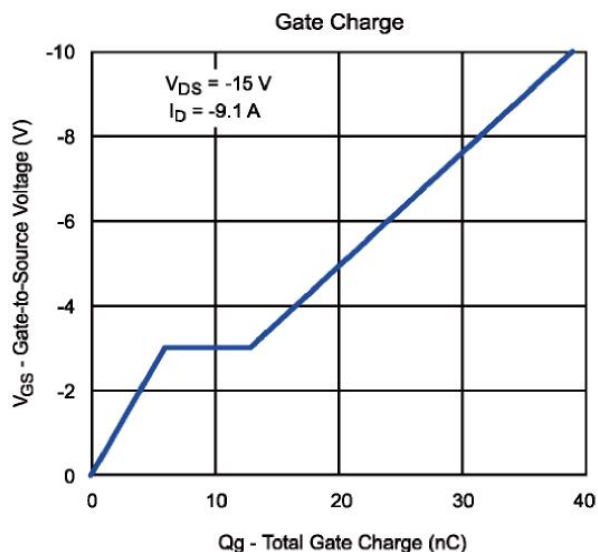


On-Region Characteristics

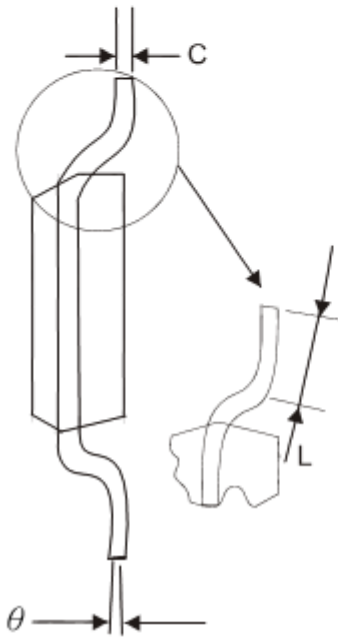
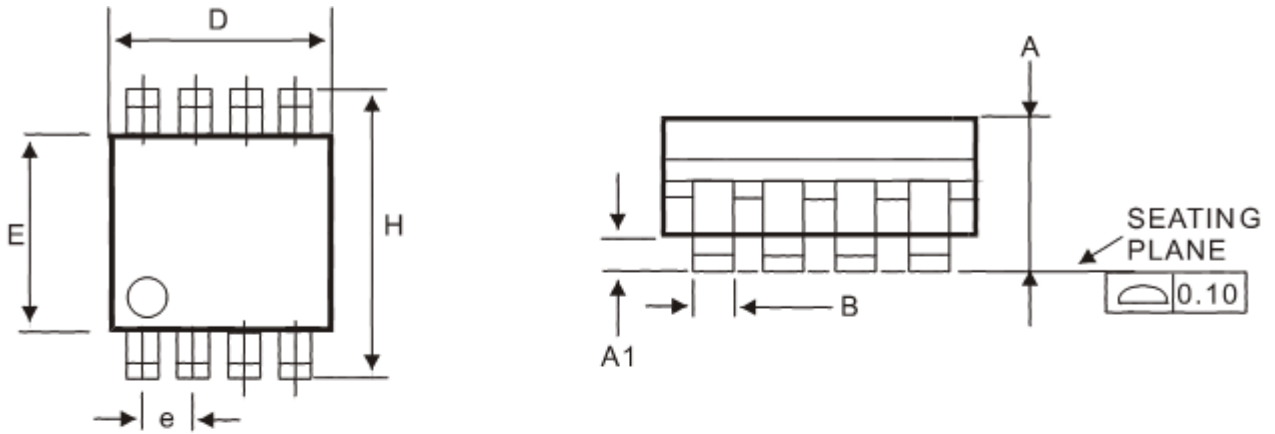


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Typical Characteristics (T_J = 25°C Noted)



SOP-8 Package Outline



| DIM | MILLIMETERS (mm) | |
|----------|------------------|------|
| | MIN | MAX |
| A | 1.35 | 1.75 |
| A1 | 0.10 | 0.25 |
| B | 0.35 | 0.49 |
| C | 0.18 | 0.25 |
| D | 4.80 | 5.00 |
| E | 3.80 | 4.00 |
| e | 1.27 BSC | |
| H | 5.80 | 6.20 |
| L | 0.40 | 1.25 |
| θ | 0° | 7° |

Note: 1. Refer to JEDEC MS-012AA.

2. Dimension "D" does not include mold flash, protrusions or gate burrs . Mold flash, protrusions or gate burrs shall not exceed 0.15 mm per side.

